

# EV32C3A5A1-8.000M TR [Click part number to visit Part Number Details page](#)

## REGULATORY COMPLIANCE (Data Sheet downloaded on Nov 17, 2017)



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## ITEM DESCRIPTION

Voltage Controlled Quartz Crystal Clock Oscillators VCXO LVC MOS/TTL (CMOS) 3.3Vdc 6 Pad 5.0mm x 7.0mm Ceramic Surface Mount (SMD) 8.000MHz  $\pm 50$ ppm Maximum 0°C to +70°C  $\pm 100$ ppm Minimum 10% Typical, 20% Maximum

## ELECTRICAL SPECIFICATIONS

|                                       |   |
|---------------------------------------|---|
| Nominal Frequency                     | 8.000MHz  |
| Frequency Tolerance/Stability         | $\pm 50$ ppm Maximum (Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, Shock, and Vibration.)                                       |
| Aging at 25°C                         | $\pm 2$ ppm/First Year Typical, $\pm 10$ ppm/10 Years Maximum   |
| Operating Temperature Range           | 0°C to +70°C  |
| Supply Voltage                        | 3.3Vdc $\pm 10\%$   |
| Input Current                         | 15mA Maximum  |
| Output Voltage Logic High (Voh)       | 90% of Vdd Minimum (IOH = -4mA)   |
| Output Voltage Logic Low (Vol)        | 10% of Vdd Maximum (IOL = +4mA)   |
| Rise/Fall Time                        | 5nSec Maximum (Measured at 20% to 80% of Waveform)  |
| Duty Cycle                            | 50 $\pm 10$ (%) (Measured at 50% of Waveform)   |
| Load Drive Capability                 | 10TTL Load or 30pF LVC MOS Load Maximum   |
| Output Logic Type                     | CMOS  |
| Absolute Pull Range                   | $\pm 100$ ppm Minimum (Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, Shock, Vibration, and Aging over the Control Voltage (Vc).) |
| Control Voltage                       | 0.3Vdc to 3.0Vdc (Test Condition for APR)   |
| Control Voltage Range                 | 0.0Vdc to Vdd   |
| Linearity                             | 10% Typical, 20% Maximum  |
| Transfer Function                     | Positive Transfer Characteristic  |
| Modulation Bandwidth                  | 10kHz Minimum (Measured at -3dB, Vc = 1.65Vdc)  |
| Input Impedance                       | 50kOhms Minimum   |
| Input Leakage Current                 | 10 $\mu$ A Maximum  |
| Phase Noise                           | All Values are Typical<br>-70dBc/Hz at offset of 10Hz<br>-100dBc/Hz at offset of 100Hz<br>-130dBc/Hz at offset of 1kHz<br>-147dBc/Hz at offset of 10kHz<br>-152dBc/Hz at offset of 100kHz<br>-155dBc/Hz at offset of 1MHz                           |
| Tri-State Input Voltage (Vih and Vil) | 90% of Vdd Minimum or No Connect to Enable Output, 10% of Vdd Maximum to Disable Output (High Impedance)  |
| RMS Phase Jitter                      | 1pSec Maximum (Fj = 12kHz to 20MHz; Random)   |
| Start Up Time                         | 10mSec Maximum  |
| Storage Temperature Range             | -55°C to +125°C   |

## ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

|                    |   |
|--------------------|---|
| ESD Susceptibility | MIL-STD-883, Method 3015, Class 1, HBM: 1500V |
| Fine Leak Test     | MIL-STD-883, Method 1014, Condition A         |
| Flammability       | UL94-V0                                       |
| Gross Leak Test    | MIL-STD-883, Method 1014, Condition C         |
| Mechanical Shock   | MIL-STD-883, Method 2002, Condition B         |

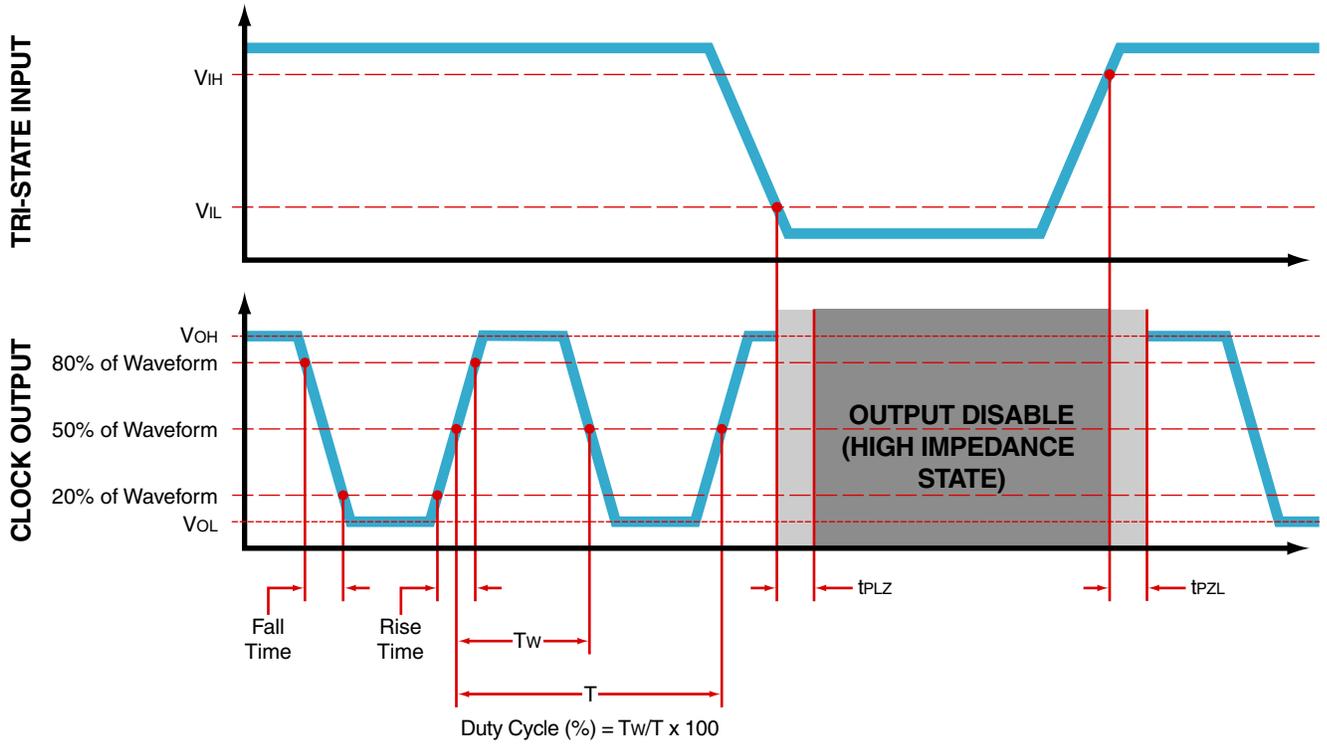
**EV32C3A5A1-8.000M TR** [Click part number to visit Part Number Details page](#)**ENVIRONMENTAL & MECHANICAL SPECIFICATIONS CONTINUED**

|                                     |                                       |
|-------------------------------------|---------------------------------------|
| <b>Moisture Resistance</b>          | MIL-STD-883, Method 1004              |
| <b>Moisture Sensitivity</b>         | J-STD-020, MSL 1                      |
| <b>Resistance to Soldering Heat</b> | MIL-STD-202, Method 210, Condition K  |
| <b>Resistance to Solvents</b>       | MIL-STD-202, Method 215               |
| <b>Solderability</b>                | MIL-STD-883, Method 2003              |
| <b>Temperature Cycling</b>          | MIL-STD-883, Method 1010, Condition B |
| <b>Vibration</b>                    | MIL-STD-883, Method 2007, Condition A |



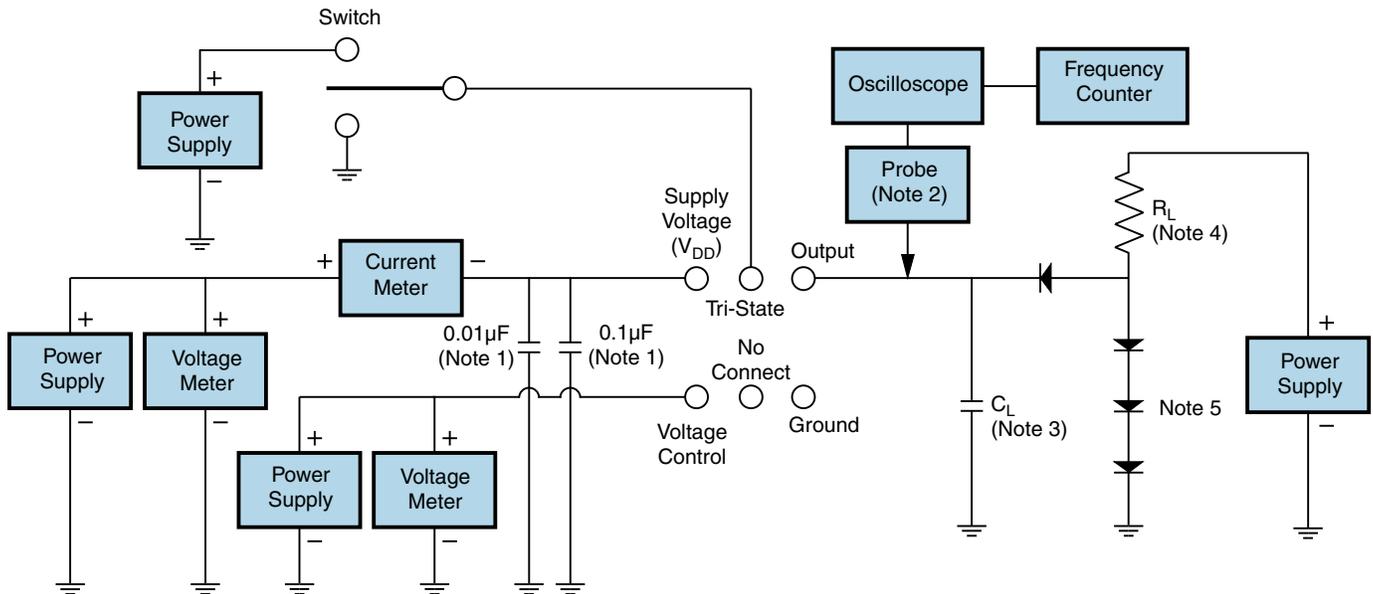
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## OUTPUT WAVEFORM & TIMING DIAGRAM



## EV32C3A5A1-8.000M TR [Click part number to visit Part Number Details page](#)

### Test Circuit for TTL Output



Note 1: An external 0.01µF ceramic bypass capacitor in parallel with a 0.1µF high frequency ceramic bypass capacitor close (less than 2mm) to the package ground and supply voltage pin is required.

Note 2: A low capacitance (<12pF), 10X attenuation factor, high impedance (>10Mohms), and high bandwidth (>300MHz) passive probe is recommended.

Note 3: Capacitance value  $C_L$  includes sum of all probe and fixture capacitance.

Note 4: Resistance value  $R_L$  is shown in Table 1. See applicable specification sheet for 'Load Drive Capability'.

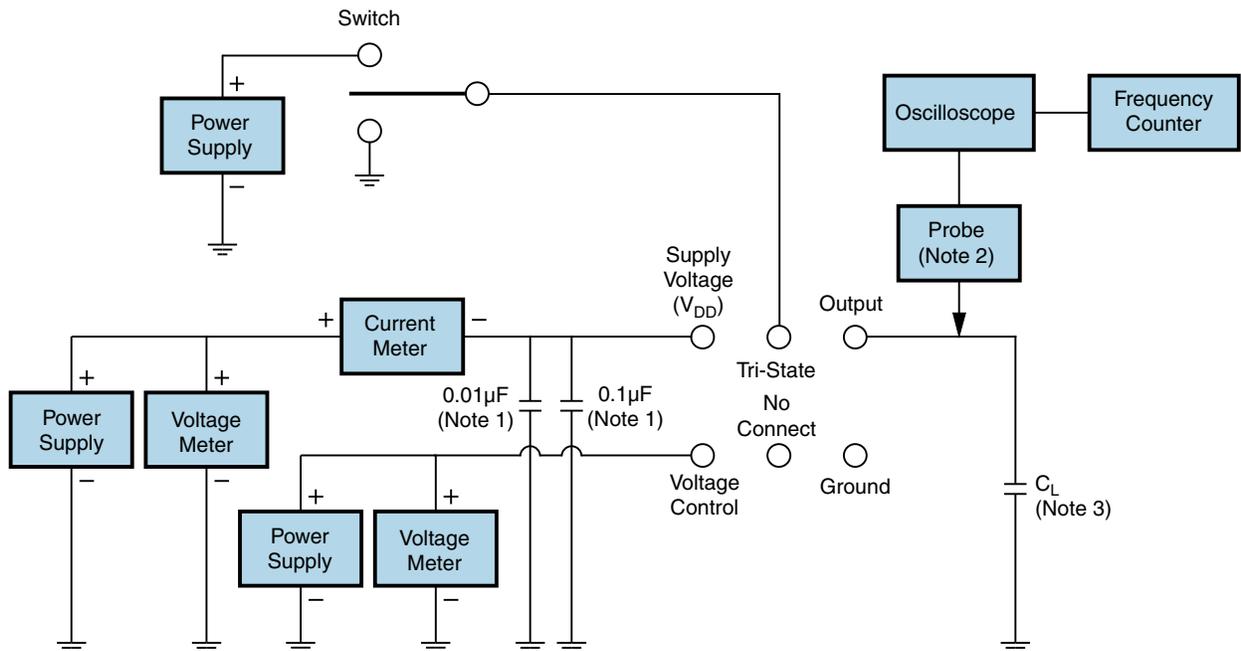
Note 5: All diodes are MMBD7000, MMBD914, or equivalent.

| Output Load Drive Capability | $R_L$ Value (Ohms) | $C_L$ Value (pF) |
|------------------------------|--------------------|------------------|
| 10TTL                        | 390                | 15               |

Table 1:  $R_L$  Resistance Value and  $C_L$  Capacitance Value Vs. Output Load Drive Capability

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## Test Circuit for CMOS Output



Note 1: An external 0.01µF ceramic bypass capacitor in parallel with a 0.1µF high frequency ceramic bypass capacitor close (less than 2mm) to the package ground and supply voltage pin is required.

Note 2: A low capacitance (<12pF), 10X attenuation factor, high impedance (>10Mohms), and high bandwidth (>300MHz) passive probe is recommended.

Note 3: Capacitance value C<sub>L</sub> includes sum of all probe and fixture capacitance.

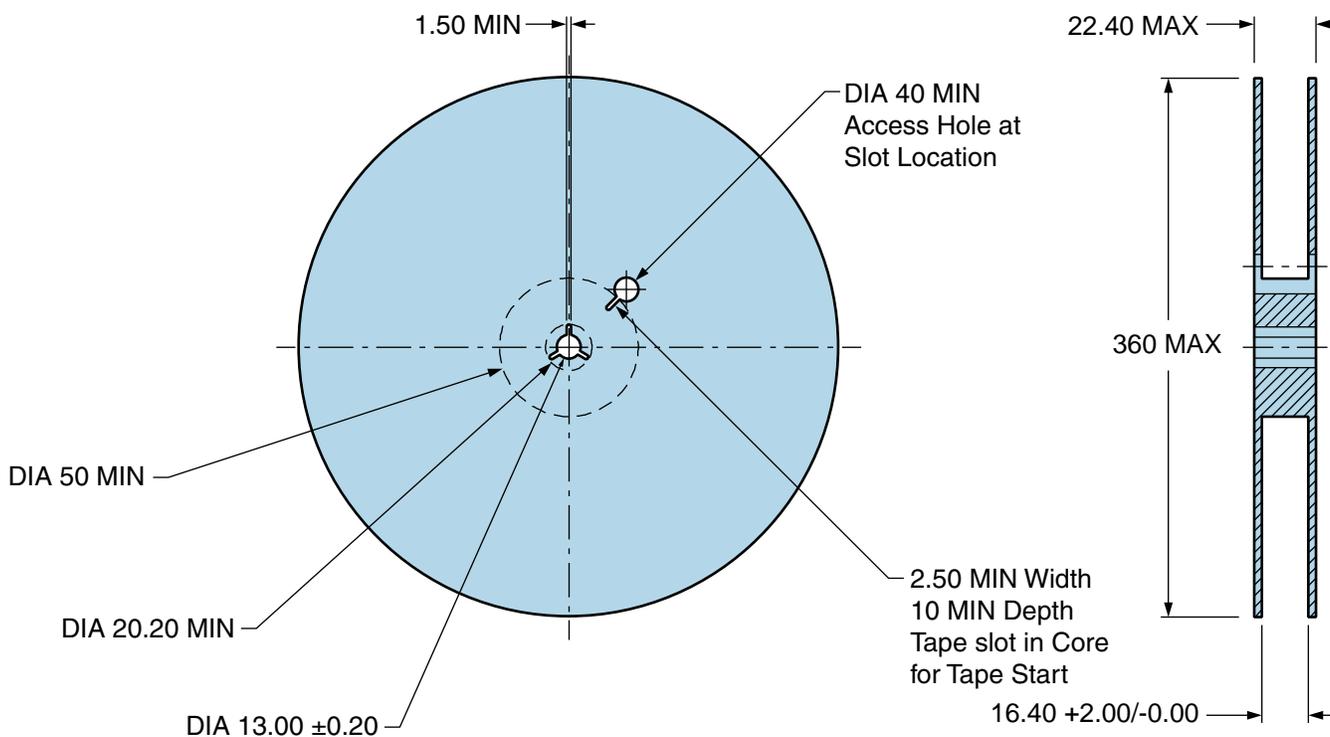
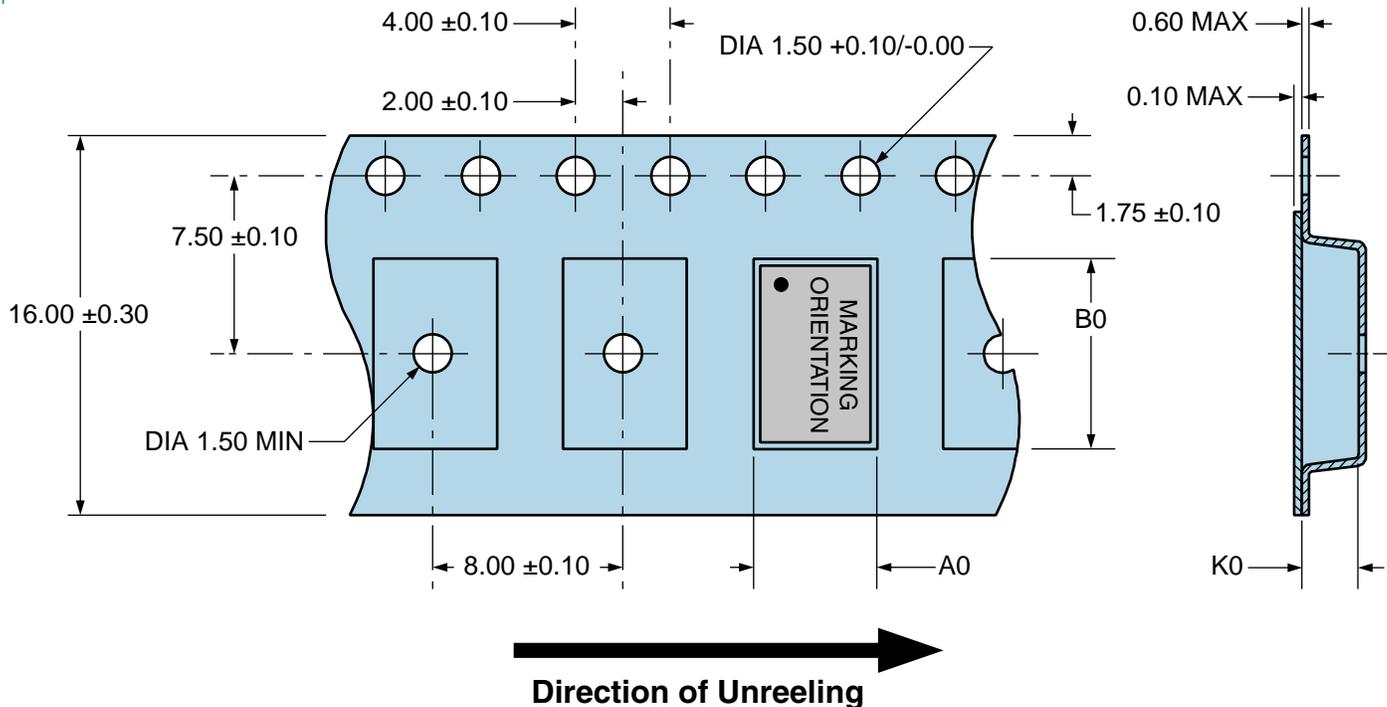
# EV32C3A5A1-8.000M TR

## Tape & Reel Dimensions

Quantity Per Reel: 1,000 units

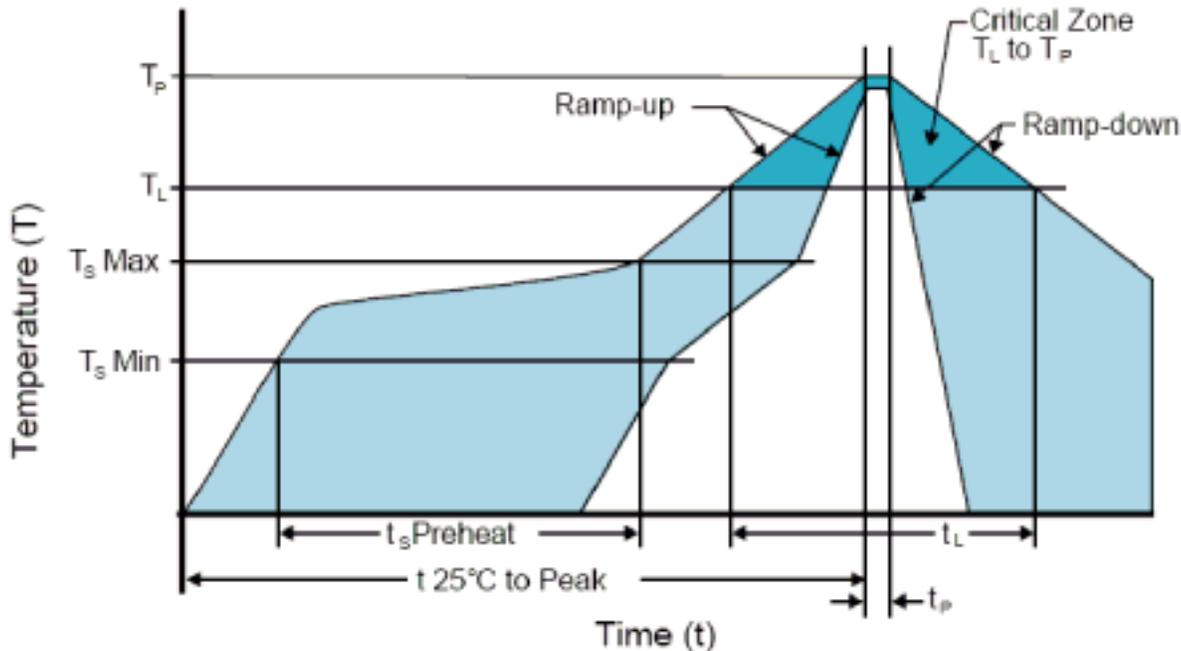
All Dimensions in Millimeters

Compliant to EIA-481



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## Recommended Solder Reflow Methods

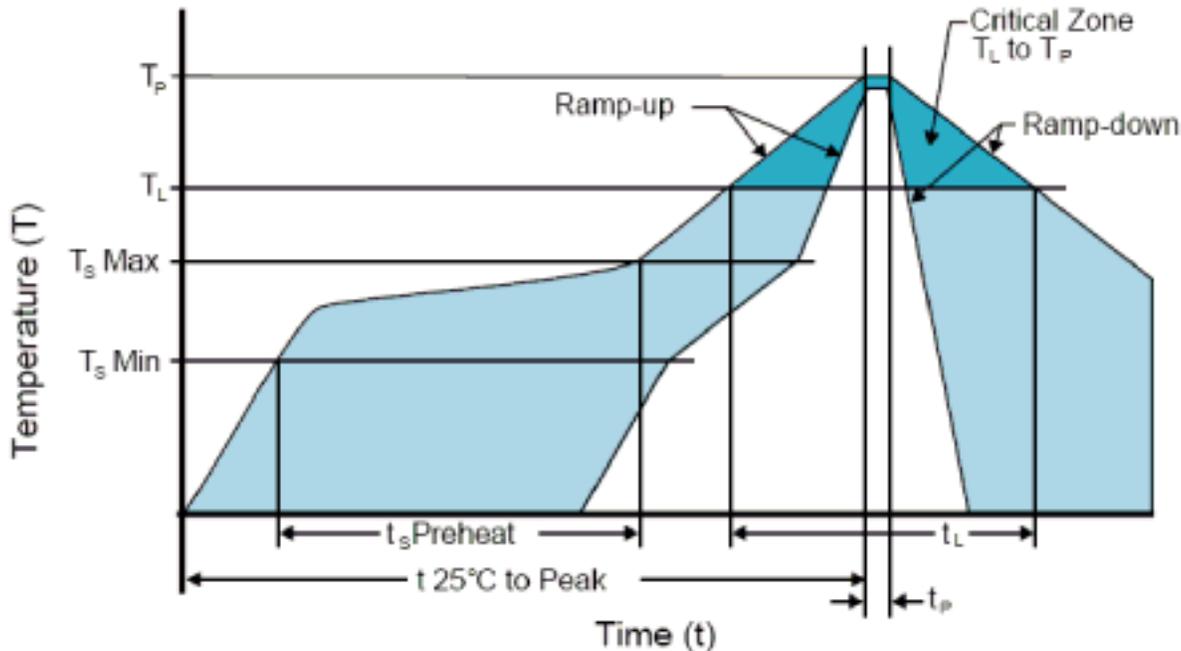


### High Temperature Infrared/Convection

|  |                                      |
|--|--------------------------------------|
| <b>Ts MAX to Tl (Ramp-up Rate)</b>         | 3°C/Second Maximum                   |
| <b>Preheat</b>                             |                                      |
| - Temperature Minimum (Ts MIN)             | 150°C                                |
| - Temperature Typical (Ts TYP)             | 175°C                                |
| - Temperature Maximum (Ts MAX)             | 200°C                                |
| - Time (ts MIN)                            | 60 - 180 Seconds                     |
| <b>Ramp-up Rate (Tl to Tp)</b>             | 3°C/Second Maximum                   |
| <b>Time Maintained Above:</b>              |                                      |
| - Temperature (Tl)                         | 217°C                                |
| - Time (tL)                                | 60 - 150 Seconds                     |
| <b>Peak Temperature (Tp)</b>               | 260°C Maximum for 10 Seconds Maximum |
| <b>Target Peak Temperature (Tp Target)</b> | 250°C +0/-5°C                        |
| <b>Time within 5°C of actual peak (tp)</b> | 20 - 40 Seconds                      |
| <b>Ramp-down Rate</b>                      | 6°C/Second Maximum                   |
| <b>Time 25°C to Peak Temperature (t)</b>   | 8 Minutes Maximum                    |
| <b>Moisture Sensitivity Level</b>          | Level 1                              |

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## Recommended Solder Reflow Methods



### Low Temperature Infrared/Convection 240°C

|  |  |
|--|--|
| Ts MAX to Tl (Ramp-up Rate)                | 5°C/Second Maximum                                     |
| <b>Preheat</b>                             |  |
| - Temperature Minimum (Ts MIN)             | N/A  |
| - Temperature Typical (Ts TYP)             | 150°C  |
| - Temperature Maximum (Ts MAX)             | N/A  |
| - Time (ts MIN)                            | 60 - 120 Seconds                                       |
| <b>Ramp-up Rate (Tl to Tp)</b>             | 5°C/Second Maximum                                     |
| <b>Time Maintained Above:</b>              |  |
| - Temperature (Tl)                         | 150°C  |
| - Time (tL)                                | 200 Seconds Maximum                                    |
| <b>Peak Temperature (Tp)</b>               | 240°C Maximum  |
| <b>Target Peak Temperature (Tp Target)</b> | 240°C Maximum 2 Times / 230°C Maximum 1 Time           |
| <b>Time within 5°C of actual peak (tp)</b> | 10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time |
| <b>Ramp-down Rate</b>                      | 5°C/Second Maximum                                     |
| <b>Time 25°C to Peak Temperature (t)</b>   | N/A  |
| <b>Moisture Sensitivity Level</b>          | Level 1  |

### Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum.

### High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum.